



# M-MOS Semiconductor Hong Kong Limited

## 30V N-Channel Enhancement-Mode MOSFET

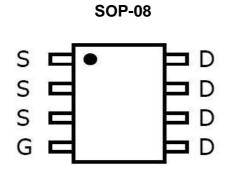
 $V_{DS} = 30V$ 

 $R_{DS(ON)}$ ,  $V_{gs}@10V$ ,  $I_{ds}@18A = 5.5m\Omega$ 

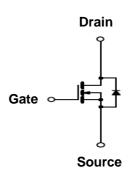
 $R_{DS(ON)}$ ,  $V_{gs}@4.5V$ ,  $I_{ds}@15A = 6.2m\Omega$ 

#### **Features**

Advanced trench process technology High Density Cell Design For Ultra Low On-Resistance Improved Shoot-Through FOM



#### **Internal Schematic Diagram**



**Top View** 

**N-Channel MOSFET** 

### **Maximum Ratings and Thermal Characteristics** ( $T_A = 25^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	30	V		
Gate-Source Voltage	V <sub>GS</sub>	± 12			
Continuous Drain Current		I <sub>D</sub>	18		
Pulsed Drain Current 1)		I <sub>DM</sub>	70	1 A	
Maximum Power Dissipation	$TA = 25^{\circ}C$	В	3	W	
	TA = 75°C	$P_{D}$	2.1		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C	
Junction-to-Ambient Thermal Resistance (PCB mounted) 2)		$R_{ hetaJA}$	62.5	°C/W	

Note: 1. Repetitive Rating: Pulse width limited by the maximum junction temperature

2. 1-in<sup>2</sup> 2oz Cu PCB board

V 1.2



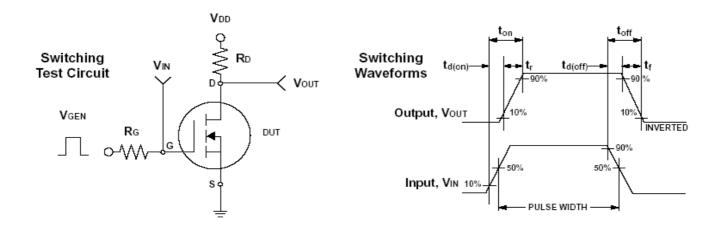


#### **ELECTRICAL CHARACTERISTICS**

Symbol	Test Condition	Min	Тур	Max	Unit
•					
BV <sub>DSS</sub>	$V_{GS} = 0V, I_D = 250uA$	30			V
R <sub>DS(on)</sub>	$V_{GS} = 10V, I_D = 18A$		4.7	5.5	mΩ
R <sub>DS(on)</sub>	$V_{GS} = 4.5V, I_D = 15A$		5.2	6.2	
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250$ uA	0.6	0.9	1.5	V
I <sub>DSS</sub>	$V_{DS} = 30V, V_{GS} = 0V$			1	uA
I <sub>GSS</sub>	$V_{GS} = \pm 12V, V_{DS} = 0V$			±100	nA
$Q_g$	$V_{DS} = 15V, I_{D} = 18A$ $V_{GS} = 10V$		76.8		nC
$Q_{gs}$			8.9		
$Q_{gd}$			9.7		
t <sub>d(on)</sub>	$V_{DD} = 15V, R_L = 0.83\Omega$ $I_D = 15A, V_{GEN} = 10V$ $R_G = 3\Omega$		10.1		ns ns
t <sub>r</sub>			7.3		
t <sub>d(off)</sub>			73.0		
t <sub>f</sub>			17.0		
C <sub>iss</sub>	$V_{DS} = 15V, V_{GS} = 0V$ f = 1.0 MHz		4405.8		pF
C <sub>oss</sub>			376.8		
C <sub>rss</sub>			306.4		
I <sub>S</sub>				4.5	А
$V_{SD}$	$I_S = 1A$ , $V_{GS} = 0V$			1	V
	$\begin{array}{c c} & BV_{DSS} \\ R_{DS(on)} \\ R_{DS(on)} \\ V_{GS(th)} \\ I_{DSS} \\ I_{GSS} \\ \\ \hline \\ Q_g \\ Q_{gs} \\ Q_{gd} \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ C_{iss} \\ C_{oss} \\ C_{rss} \\ \\ \hline \\ I_{S} \\ \end{array}$	$ \begin{array}{ c c c } BV_{DSS} & V_{GS} = 0V, \ I_D = 250 uA \\ \hline R_{DS(on)} & V_{GS} = 10V, \ I_D = 18A \\ \hline R_{DS(on)} & V_{GS} = 4.5V, \ I_D = 15A \\ \hline V_{GS(th)} & V_{DS} = V_{GS}, \ I_D = 250 uA \\ \hline I_{DSS} & V_{DS} = 30V, \ V_{GS} = 0V \\ \hline I_{GSS} & V_{GS} = \pm 12V, \ V_{DS} = 0V \\ \hline \hline Q_g & V_{DS} = 15V, \ I_D = 18A \\ \hline V_{GS} = 10V & V_{DS} = 10V \\ \hline Q_{gd} & V_{DD} = 15V, \ R_L = 0.83\Omega \\ \hline I_D = 15A, \ V_{GEN} = 10V \\ \hline R_G = 3\Omega & V_{DS} = 15V, \ V_{GS} = 0V \\ \hline C_{iss} & V_{DS} = 15V, \ V_{GS} = 0V \\ \hline C_{rss} & V_{DS} = 15V, \ V_{GS} = 0V \\ \hline I_S & I_S = 15V, \ V_{GS} = 0V \\ \hline \end{array} $	$ \begin{array}{ c c c c } \hline BV_{DSS} & V_{GS} = 0V, \ I_D = 250 uA \\ \hline R_{DS(on)} & V_{GS} = 10V, \ I_D = 18A \\ \hline R_{DS(on)} & V_{GS} = 4.5V, \ I_D = 15A \\ \hline V_{GS(th)} & V_{DS} = V_{GS}, \ I_D = 250 uA \\ \hline I_{DSS} & V_{DS} = 30V, \ V_{GS} = 0V \\ \hline I_{GSS} & V_{GS} = \pm 12V, \ V_{DS} = 0V \\ \hline \hline Q_g & V_{DS} = 15V, \ I_D = 18A \\ \hline V_{GS} = 10V & \\ \hline Q_{gd} & V_{DD} = 15V, \ R_L = 0.83\Omega \\ \hline I_D = 15A, \ V_{GEN} = 10V \\ \hline R_G = 3\Omega & \\ \hline C_{iss} & \\ \hline C_{oss} & \\ \hline C_{rss} & \\ \hline I_S & \\ \hline \end{array} $	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

Note: Pulse test: pulse width <= 300us, duty cycle<= 2%

<sup>3.</sup> Guaranteed by design; not subject to production testing



V 1.2



#### **Notice**

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V 1.2